

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
-100V	16mΩ@-10V	-60A



合肥矽普半导体

Siliup Semiconductor Technology Co., Ltd

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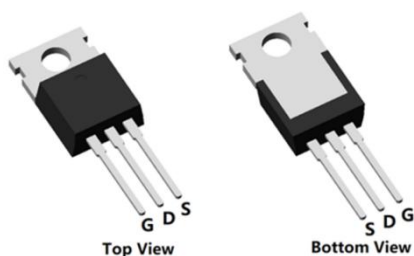
Feature

- Fast Switching
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

Applications

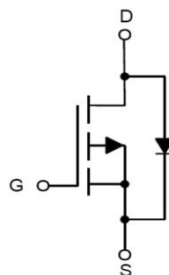
- PWM Application
- Hard switched and high frequency circuits
- Power Management

Package

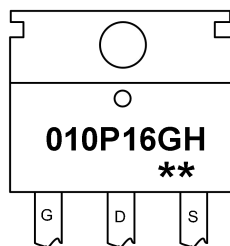


TO-220-3L(1:G 2:D 3:S)

Circuit diagram



Marking



010P16GH : Product code
****** : Week code

Order Information

Device	Package	Unit/Tube
SP010P16GHTQ	TO-220-3L	50

Absolute maximum ratings (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	-100	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current (Tc=25°C)	I_D	-60	A
Continuous Drain Current (Tc=100°C)	I_D	-40	A
Pulsed Drain Current	I_{DM}	-240	A
Single Pulse Avalanche Energy ¹	E_{AS}	625	mJ
Power Dissipation (Tc=25°C)	P_D	180	W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	0.69	°C/W
Storage Temperature Range	T_{STG}	-55 to 150	°C
Operating Junction Temperature Range	T_J	-55 to 150	°C

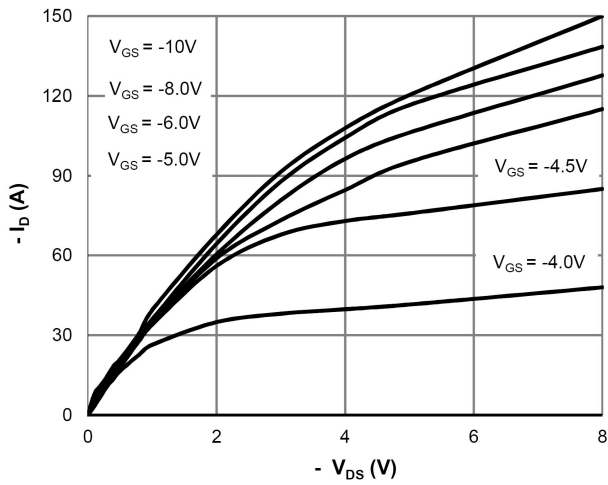
Electrical characteristics (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	VGS=0V , ID= -250uA	-100	-	-	V
Drain-Source Leakage Current	IDSS	VDS=-80V , VGS=0V , TJ=25℃	-	-	-1	uA
Gate-Source Leakage Current	IGSS	VGS=±20V , VDS=0V	-	-	±100	nA
Gate Threshold Voltage	VGS(th)	VGS=VDS , ID = -250uA	-2	-3	-4	V
Static Drain-Source On-Resistance	RDS(ON)	VGS=-10V , ID= -20A	-	16	20	mΩ
Dynamic characteristics						
Input Capacitance	Ciss	VDS=-50V , VGS=0V , f=1MHz	-	6825	-	pF
Output Capacitance	Coss		-	752	-	
Reverse Transfer Capacitance	Crss		-	296	-	
Total Gate Charge	Qg	VDS=-50V , VGS=10V , ID=-20A	-	98	-	nC
Gate-Source Charge	Qgs		-	26	-	
Gate-Drain Charge	Qgd		-	13	-	
Switching Characteristics						
Turn-On Delay Time	Td(on)	VDD=-50V , VGS=10V , RG=1.6Ω,ID=-20A	-	16	-	nS
Rise Time	Tr		-	58	-	
Turn-Off Delay Time	Td(off)		-	145	-	
Fall Time	Tf		-	56	-	
Diode Characteristics						
Diode Forward Voltage	VSD	VGS=0V , IS=-1A , TJ=25℃	-	-	-1.2	V
Maximum Body-Diode Continuous Current	IS		-	-	-60	A
Reverse Recovery Time	Trr	IS=-20A, di/dt=100A/us, TJ=25℃	-	96	-	nS
Reverse Recovery Charge	Qrr		-	205	-	nC

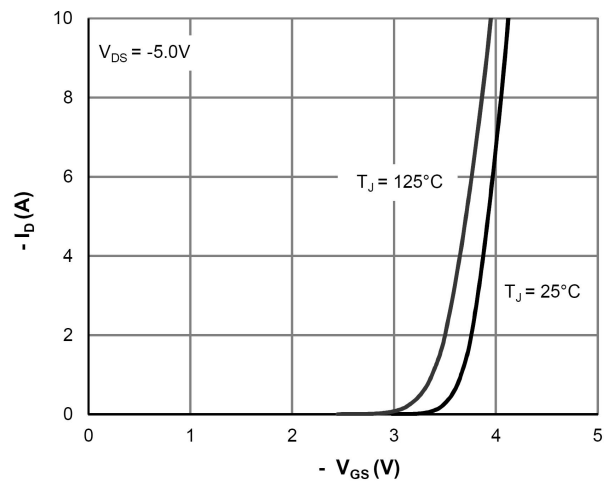
Note :

1. The test condition is $V_{DD}=-50V, V_{GS}=-10V, L=0.5mH, R_G=25\Omega$

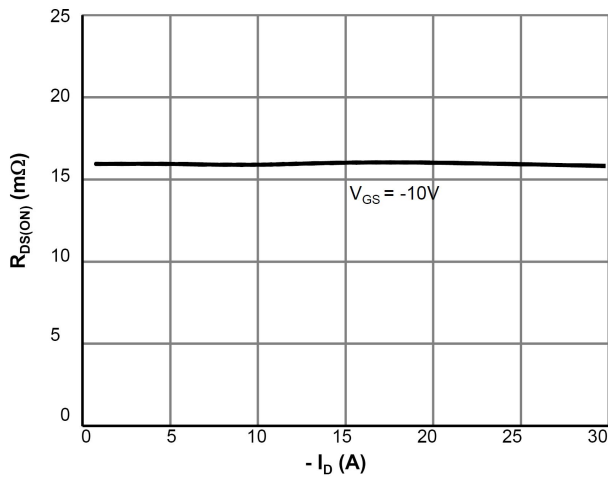
Typical Characteristics



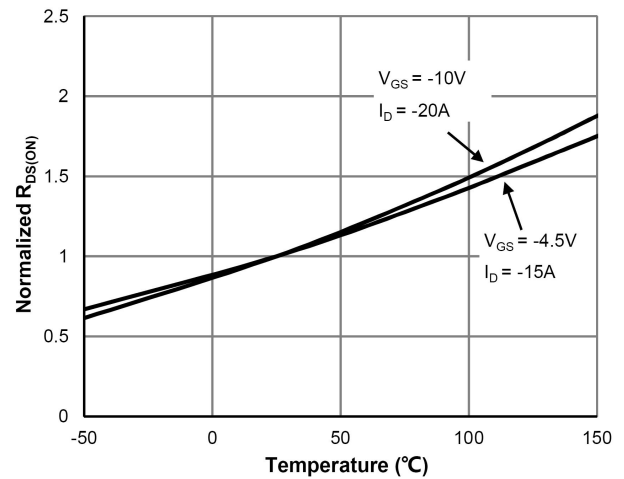
Saturation Characteristics



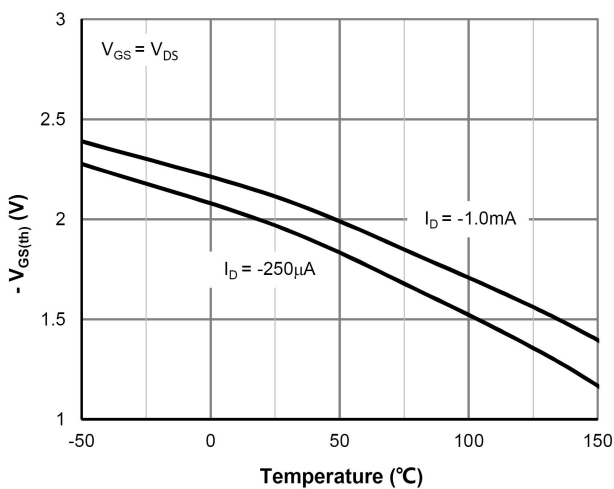
Transfer Characteristics



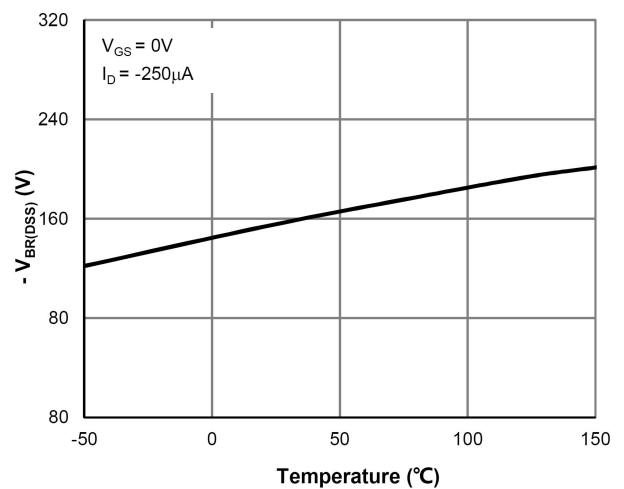
$R_{DS(ON)}$ vs. Drain Current



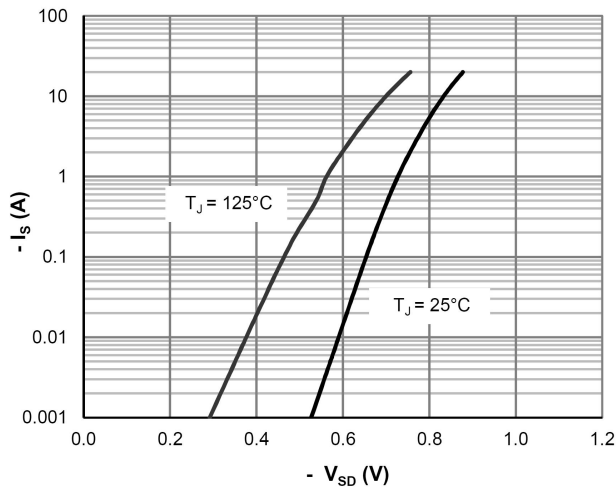
$R_{DS(ON)}$ vs. Junction Temperature



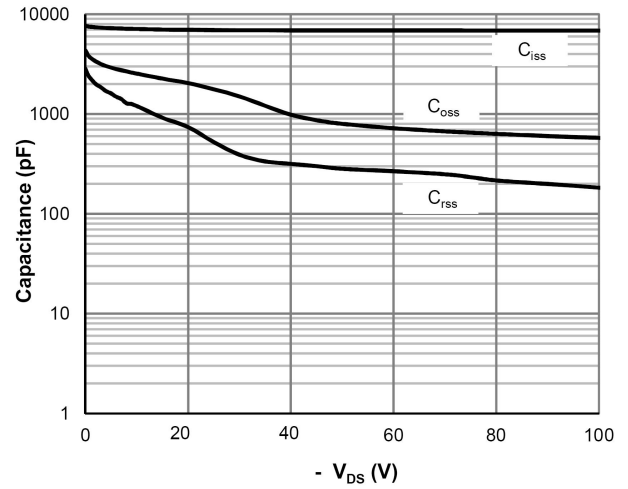
$V_{GS(th)}$ vs. Junction Temperature



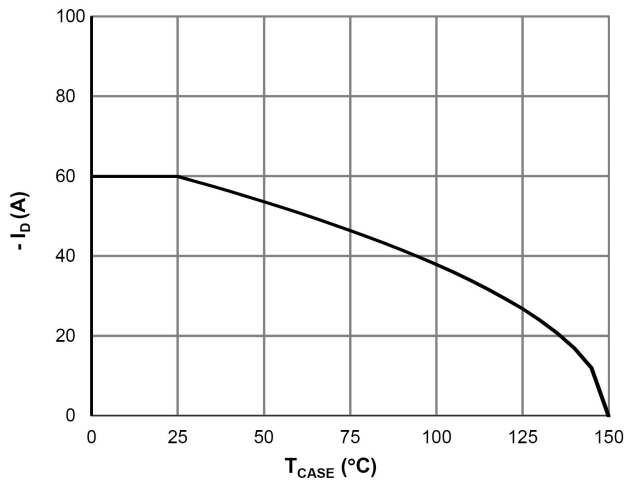
$V_{BR(DSS)}$ vs. Junction Temperature



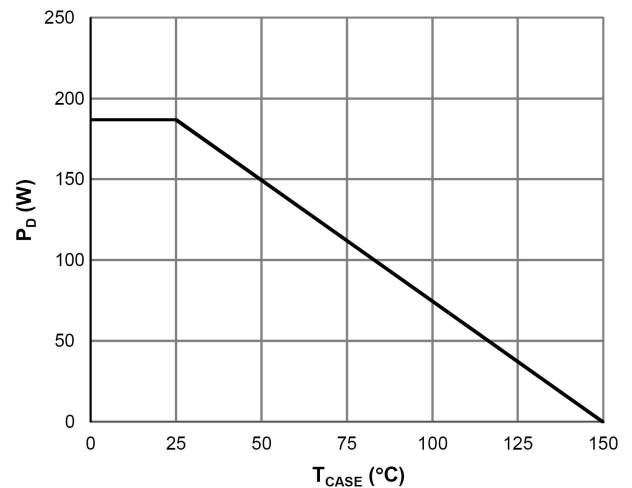
Body-Diode Characteristics



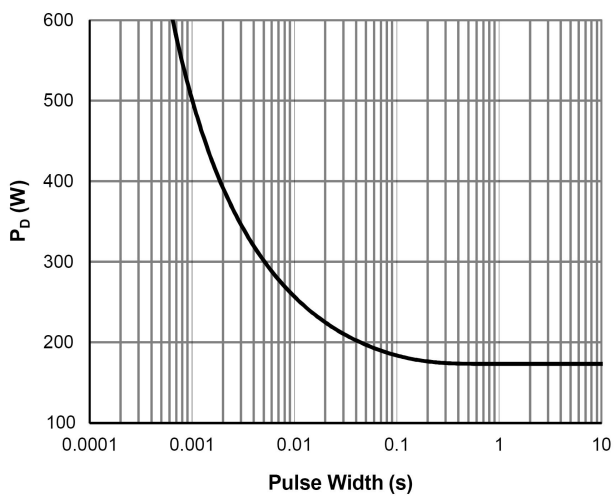
Capacitance Characteristics



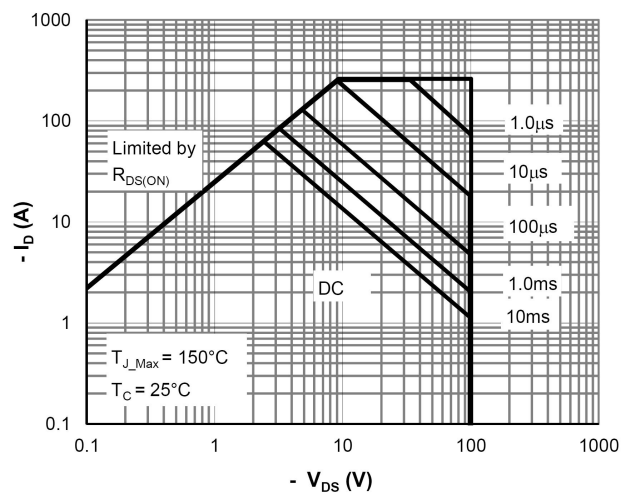
Current De-rating



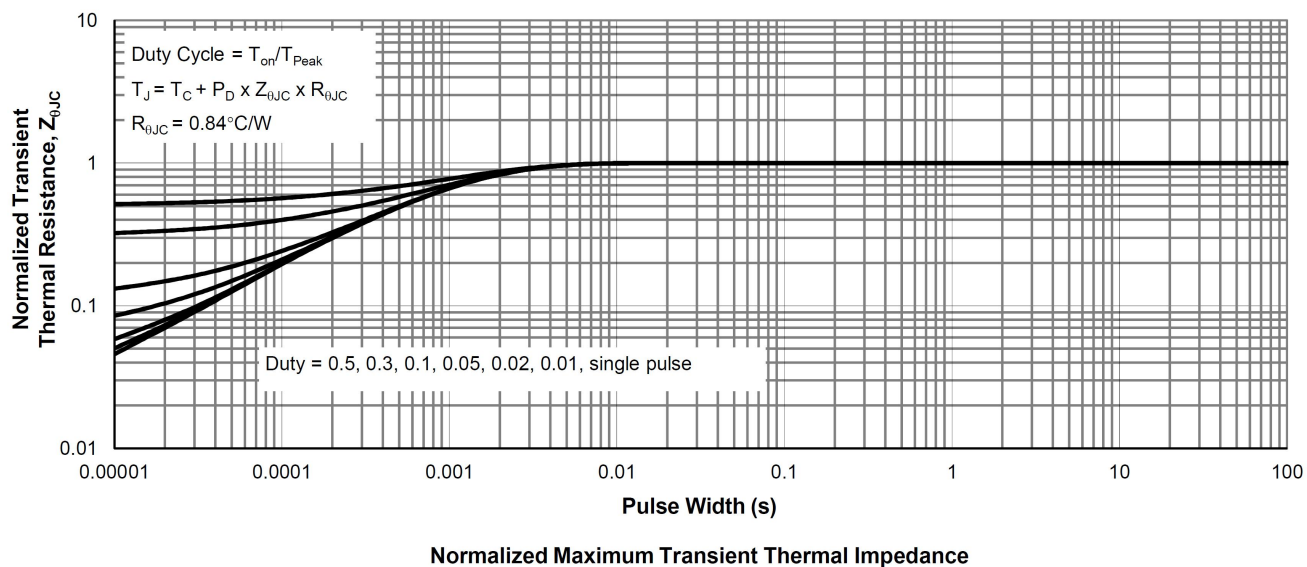
Power De-rating

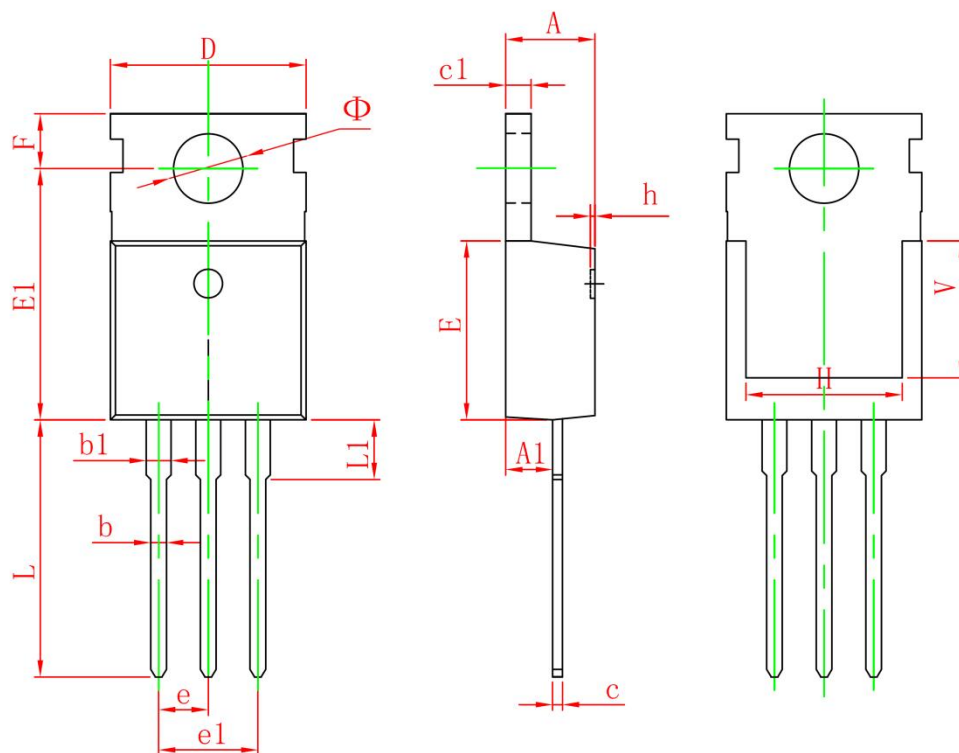


Single Pulse Power Rating, Junction-to-Case



Maximum Safe Operating Area



TO-220-3L Package Information


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.950	9.750	0.352	0.384
E1	12.650	13.050	0.498	0.514
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	6.900 REF.		0.276 REF.	
Φ	3.400	3.800	0.134	0.150